

## 2A, 200V- 1000V Fast Recovery Surface Mount Rectifiers

### **FEATURES**

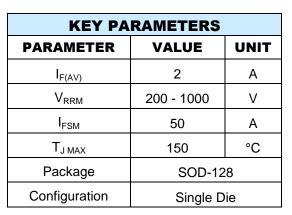
- Glass passivated junction chip
- Ideal for automated placement
- Low power loss, high efficiency
- Fast switching for high efficiency
- Low profile package
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

ΔΡ	10		$\sim$	~
		4		<b>~</b>

- High frequency rectification
- Freewheeling application
- · Switching mode converters and inverters, computer and telecommunication.

845	$\sim$ 11		10	A I	D 4	<b>T</b> A
	CH.	AN	IG	AL	DF	ATA

- Case: SOD-128
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Pure tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 0.027 g (approximately)











**SOD-128** 

ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise noted)								
PARAMETER		SYMBOL	RS2DFS	RS2GFS	RS2JFS	RS2KFS	RS2MFS	UNIT
Marking code on the devi	ice		RS2DFS	RS2GFS	RS2JFS	RS2KFS	RS2MFS	
Repetitive peak reverse v	oltage/	$V_{RRM}$	200	400	600	800	1000	V
Reverse voltage, total rms value		$V_{R(RMS)}$	140	280	420	560	700	V
Forward current		I <sub>F</sub>	2					Α
Surge peak forward current, single half sine-		1	50					Α
wave superimposed on rated load per diode	1.0ms at T <sub>A</sub> = 25°C	I <sub>FSM</sub>	140					А
Junction temperature		T <sub>J</sub>	-55 to +150					°C
Storage temperature		T <sub>STG</sub>	-55 to +150					°C

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THERMAL PERFORMANCE					
PARAMETER	SYMBOL	TYP	UNIT		
Junction-to-lead thermal resistance	$R_{\Theta JL}$	16	°C/W		
Junction-to-ambient thermal resistance	$R_{\Theta JA}$	73	°C/W		
Junction-to-case thermal resistance	R <sub>eJC</sub>	14	°C/W		

Thermal Performance Note: Units mounted on PCB (5mm x 5mm Cu pad test board)

PARAMET	ΓER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
		I <sub>F</sub> = 1.0A, T <sub>J</sub> = 25°C		0.93	-	V
	RS2DFS	$I_F = 2.0A, T_J = 25^{\circ}C$		1.01	1.30	V
	RS2GFS RS2JFS	I <sub>F</sub> = 1.0A, T <sub>J</sub> = 125°C		0.78	-	V
Famuuand valtage (1)		$I_F = 2.0A, T_J = 125^{\circ}C$		0.88	1.02	V
Forward voltage <sup>(1)</sup>		I <sub>F</sub> = 1.0A, T <sub>J</sub> = 25°C	V <sub>F</sub>	0.98	-	V
	RS2KFS	$I_F = 2.0A, T_J = 25^{\circ}C$		1.06	1.30	V
	RS2MFS	I <sub>F</sub> = 1.0A, T <sub>J</sub> = 125°C		0.83	-	V
		I <sub>F</sub> = 2.0A, T <sub>J</sub> = 125°C		0.93	1.05	V
2 (2)		T <sub>J</sub> = 25°C	ı	-	1	μΑ
Reverse current @ rated V <sub>R</sub>		T <sub>J</sub> = 125°C	l <sub>R</sub>	-	40	μΑ
	RS2DFS RS2GFS			-	150	ns
Reverse recovery time	RS2JFS	I <sub>F</sub> =0.5A,I <sub>R</sub> =1.0A, Irr=0.25A	t <sub>rr</sub>	-	250	ns
	RS2KFS RS2MFS	0.20/		-	500	ns
Junction capacitance	RS2DFS RS2GFS RS2JFS	1 MHz, V <sub>R</sub> =4.0V	С	11	-	pF
·	RS2KFS RS2MFS			10	-	pF

### Notes:

- (1) Pulse test with PW=0.3 ms
- (2) Pulse test with PW=30 ms

ORDERING INFORMATION				
ORDERING CODE <sup>(1)</sup>	PACKAGE	PACKING		
RS2xFS M3G	SOD-128	3,500 / 7" reel		
RS2xFS M2G	SOD-128	14,000 / 13" reel		

#### Notes:

(1) "x" defines voltage from 200V(RS2DFS) to 1000V(RS2MFS)



#### **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

Fig.1 Forward Current Derating Curve

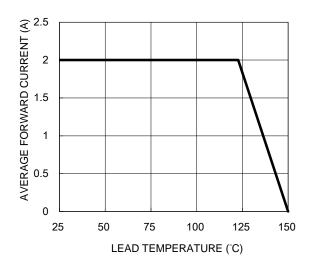


Fig.3 Typical Reverse Characteristics

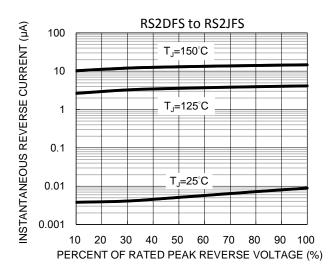


Fig.5 Typical Reverse Characteristics

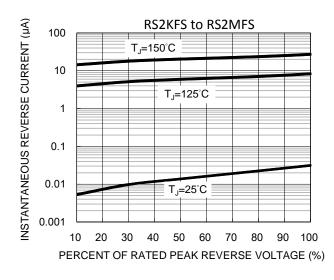


Fig.2 Typical Junction Capacitance

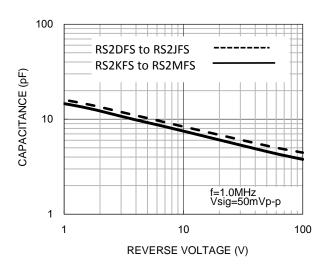


Fig.4 Typical Forward Characteristics

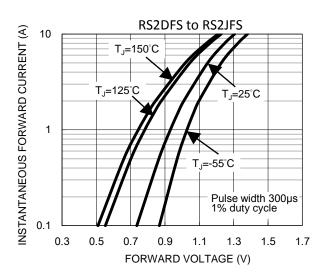
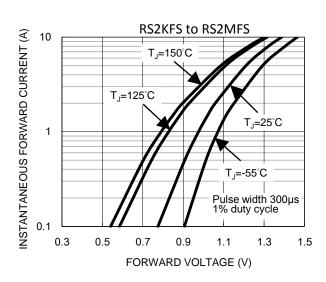


Fig.6 Typical Forward Characteristics





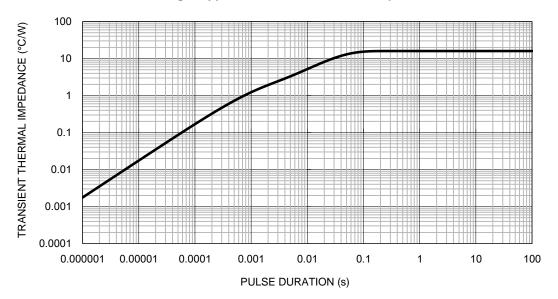
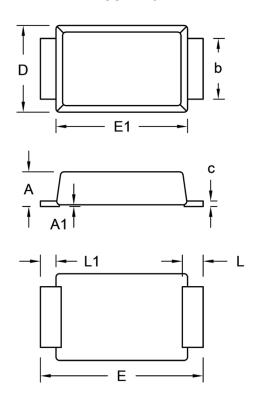


Fig.7 Typical Transient Thermal Impedance



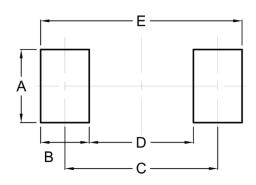
### **PACKAGE OUTLINE DIMENSIONS**

**SOD-128** 



DIM.	Unit		Unit (	(inch)
DIIVI.	Min.	Max.	Min.	Max.
Α	0.90	1.10	0.035	0.043
A1	0.00	0.10	0.000	0.004
b	1.60	1.90	0.063	0.075
С	0.10	0.22	0.004	0.009
D	2.30	2.70	0.091	0.106
E	4.40	5.00	0.173	0.197
E1	3.60	4.00	0.142	0.157
L	0.40	0.80	0.016	0.031
L1	0.30	0.60	0.012	0.024

### **SUGGESTED PAD LAYOUT**



Symbol	Unit (mm)	Unit (inch)
Α	2.10	0.083
В	1.40	0.055
С	4.40	0.173
D	3.00	0.118
E	5.80	0.228

### **MARKING DIAGRAM**



P/N = Marking Code YW = Date Code F = Factory Code

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